National Semiconductor

MICROCIRCUIT DATA SHEET

MN54F14-X REV 2A0

Original Creation Date: 03/12/96
Last Update Date: 07/22/03
Last Major Revision Date: 06/02/03

HEX INVERTER SCHMITT TRIGGER

General Description

The F14 contains six logic inverters which accept standard TTL input signals and provide standard TTL output levels. They are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals. In addition, they have greater noise margin than conventional inverters.

Each circuit contains s Schmitt trigger followed by a Darlington level shifter and a phase splitter driving a TTL totem-pole output. The Schmitt trigger uses positive feedback to effectively speed-up slow input transistion, and provide different input threshold voltages for positive and negative-going transitions. This hysteresis between the positive-going and negative-going input thresholds (typically 800 mV) is determined internally by resistor ratios and is essentially insensitive to temperature and supply voltage variations.

Industry Part Number

54F14

NS Part Numbers

54F14DM-MLS
54F14DMQB.
54F14FMQB.
54F14LMQB.

Prime Die

M014

Controlling Document

SEE FEATURES SECTION

Processing

MIL-STD-883, Method 5004

Quality Conformance Inspection

MIL-STD-883, Method 5005

Subgrp	Description	Temp (°C)
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55

Features

- Guaranteed 4000V minimum ESD protection

CONTROLLING DOCUMENTS:

54F14DMQB. 5962-8875201CA
54F14FMQB. 5962-8875201DA
54F14LMQB. 5962-88752012A

(Absolute Maximum Ratings)

(Note 1)

Storage Temperature	
	-65 C to +150 C
Ambient Temperature under Bias	
	-55 C to +125 C
Junction Temperature under Bias	
	-55 C to +175 C
Vcc Pin Potential to Ground Pin	
	-0.5V to +7.0V
Input Voltage (Note 2)	
	-0.5V to +7.0V
Input Current (Note 2)	
	-30 mA to +5.0mA
Voltage Applied to Output in HIGH State (with Vcc=0V)	
Standard Output	-0.5V to Vcc
TRI-STATE Output	-0.5V to +5.5V
Current Applied to Output in LOW State (Max)	
	twice the rated Iol(mA)
ESD Last Passing Voltage (Min)	
	4000V

Note 1: Absolute Maximum ratings are those values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.
Note 2: Either voltage limit or current limit is sufficient to protect inputs.

Recommended Operating Conditions

Free Air Ambient Temperature	
Commercial	0 C to +70 C
Military	-55 C to +125 C
Supply Voltage	
Military	+4.5V to +5.5V
Commercial	+4.5V to +5.5V

Electrical Characteristics

DC PARAMETER

(The following conditions apply to all the following parameters, unless otherwise specified.)
DC: VCC 4.5V to 5.5V, Temp range: -55C to 125C

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
IIH	Input High Current	VCC=5.5V, VM=2.7V	1, 3	INPUTS		20	uA	1, 2, 3
IBVI	Input High Current	VCC=5.5V, VM=7.0V	1, 3	INPUTS		100	uA	1, 2, 3
IIL	Input LOW Current	VCC=5.5V, VM=0.5V	1, 3	INPUTS		-0.6	mA	1, 2, 3
VOL	Output LOW Voltage	VCC=4.5V, VIH=2.0V, IOL=20mA	1, 3	OUTPUTS		0.5	V	1, 2, 3
VOH	Output HIGH Voltage	VCC=4.5V, VIL=0.7V, IOH=-1.0mA	1, 3	OUTPUTS	2.5		V	1, 2, 3
IOS	Short-Circuit Current	VCC=5.5V, VM=0.0V	1, 3	OUTPUTS	-60	-150	mA	1, 2, 3
VCD	Input Clamp Diode Voltage	VCC=4.5V, IM=-18mA	1, 3	INPUTS		-1.2	V	1, 2, 3
VT+	Positive-Going Threshold	VCC= 5.0V	1, 3	INPUTS	1.4	2.0	V	1, 2, 3
VT-	Negative-Going Threshold	VCC=5.0V	1, 3	INPUTS	0.7	1.1	V	1, 2, 3
VT	Hysteresis	VCC=5.0V	1, 3	INPUTS	0.3		V	1, 2, 3
ICCH	Supply Current	VCC=5.5V	1, 3	VCC		25	mA	1, 2, 3
ICCL	Supply Current	VCC=5.5V	1, 3	VCC		25	mA	1, 2, 3
ICEX	Output HIGH Leakage Current	VCC=5.5V, VINL=0.0V, VINH=5.5V, VM=5.5V	1, 3	OUTPUTS		250	uA	1, 2, 3

AC PARAMETER

(The following conditions apply to all the following parameters, unless otherwise specified.)
AC: CL=50pf, RL=500 OHMS, TR=2.5ns, TF=2.5ns SEE AC FIGS

tpLH	Propagation Delay	VCC=5.0V @25C, VCC=4.5V & 5.5V @-55/125C	2, 5	In to $\overline{On}$	4.0	11.0	ns	9
			2, 5	In to $\overline{On}$	4.0	13.0	ns	10, 11
tpHL	Propagation Delay	VCC=5.0V @25C, VCC=4.5V & 5.5V @-55/125C	2, 5	In to $\overline{On}$	3.5	8.0	ns	9
			2, 5	In to $\overline{On}$	3.5	10.0	ns	10, 11

Note 1: Screen tested 100% on each device at +25C, +125C & -55C temperature, subgroups A1, 2, 3, 7 & 8.
Note 2: Screen tested 100% on each device at +25C temperature only, subgroup A9.

(Continued)

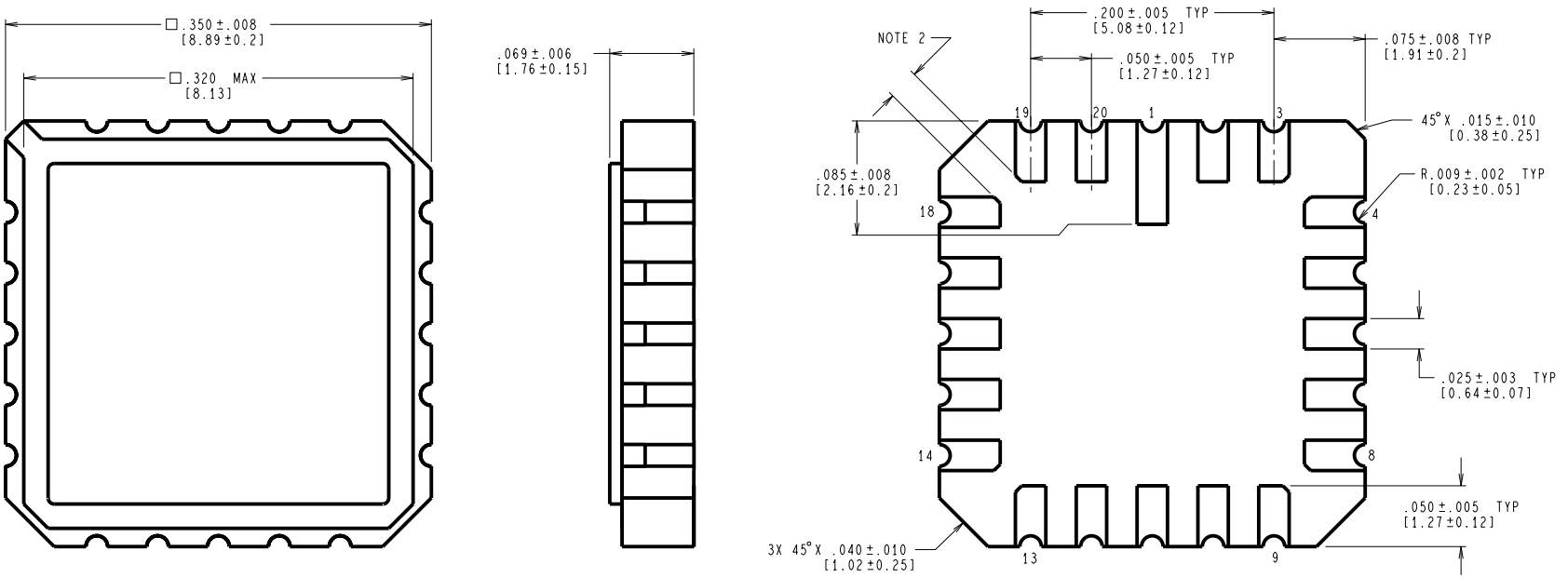
Note 3: Sample tested (Method 5005, Table 1) on each MFG. lot at +25C, +125C & -55C temperature, subgroups A1, 2, 3, 7 & 8.
Note 4: Sample tested (Method 5005, Table 1) on each MFG. lot at +25C subgroup A9, and at +125C & -55C temperature, subgroups 10 & 11.
Note 5: Sample tested (Method 5005, table 1) on each MFG. lot at +25C, +125C & -55C, subgroups A9, A10 & A11.

Graphics and Diagrams

GRAPHICS#	DESCRIPTION
E20ARE	LCC (E), TYPE C, 20 TERMINAL(P/P DWG)
J14ARH	CERDIP (J), 14 LEAD (P/P DWG)
W14BRN	CERPACK (W), 14 LEAD (P/P DWG)

See attached graphics following this page.

REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
E	REVISE AND REDRAW.	10005	02/10/94	DEG/



NOTES: UNLESS OTHERWISE SPECIFIED.

1. LEAD FINISH TO BE ONE OF THE FOLLOWING:

   a. 50 MICROINCHES/12.7 MICROMETERS MINIMUM GOLD PLATING OVER 50-350 MICROINCHES/1.27-8.89 MICROMETERS NICKEL.

   b. SOLDER DIP.
   SOLDER THICKNESS PER LATEST REVISION OF MIL-STD-1835.

2. CORNER PADS MAY HAVE A 45°X.020IN/0.51mm MAXIMUM CHAMFER TO ACCOMPLISH THE .015IN/0.38mm DIMENSION.

4. REFERENCE JEDEC REGISTRATION MS-004, VARIATION CB, DATED 7/90.

CONTROLLING DIMENSION IS INCH
VALUES IN [ ] ARE MILLIMETERS

MIL/AERO
CONFIGURATION CONTROL

APPROVALS	DATE
DRAWN: Dwayne Grady	02/10/94
DFTG. CHK.	
ENGR. CHK.	
APPROVAL	

PROJECTION
INCH [MM]

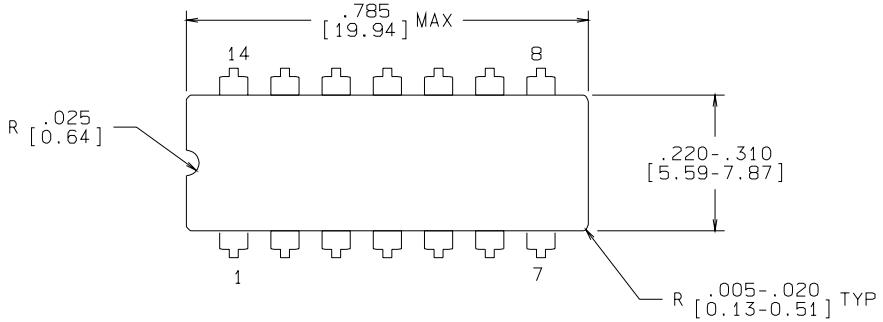
NATIONAL SEMICONDUCTOR CORPORATION
2900 Semiconductor Drive, Santa Clara, CA 95052-8090

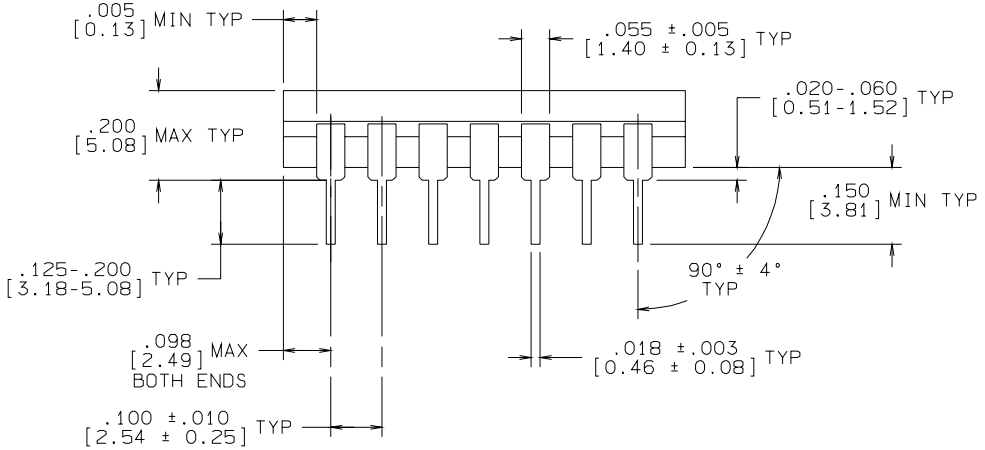
LEADLESS CHIP CARRIER, TYPE C, 20 TERMINAL

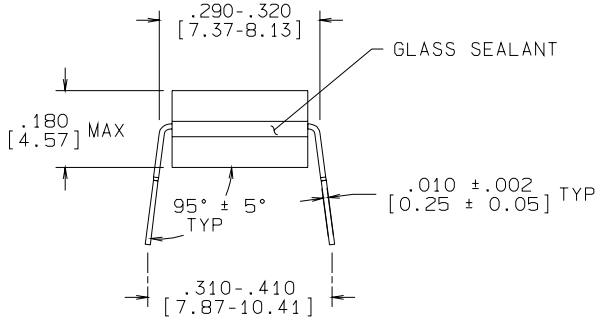
SCALE	SIZE	DRAWING NUMBER	REV
N/A	C	MKT-E20A	E

DO NOT SCALE DRAWING | SHEET 1 of 1

REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
H	REVISE PER CURRENT STD; REDRAW	10001	09/15/93	TL/







CONTROLLING DIMENSION: INCH

MIL/AERO CONFIGURATION CONTROL

MIL-M-38510 CONFIGURATION CONTROL

NOTES: UNLESS OTHERWISE SPECIFIED

1. LEAD FINISH TO BE 200 MICROINCHES / 5.08 MICROMETERS MINIMUM SOLDER MEASURED AT THE CREST OF THE MAJOR FLATS.
2. JEDEC REGISTRATION MO-036, VARIATION AB, DATED 04/1981.

APPROVALS	DATE
DRAWN T. LEQUANG	09/15/93
DFTG. CHK.	
ENGR. CHK.	
APPROVAL	

PROJECTION

INCH
[MM]

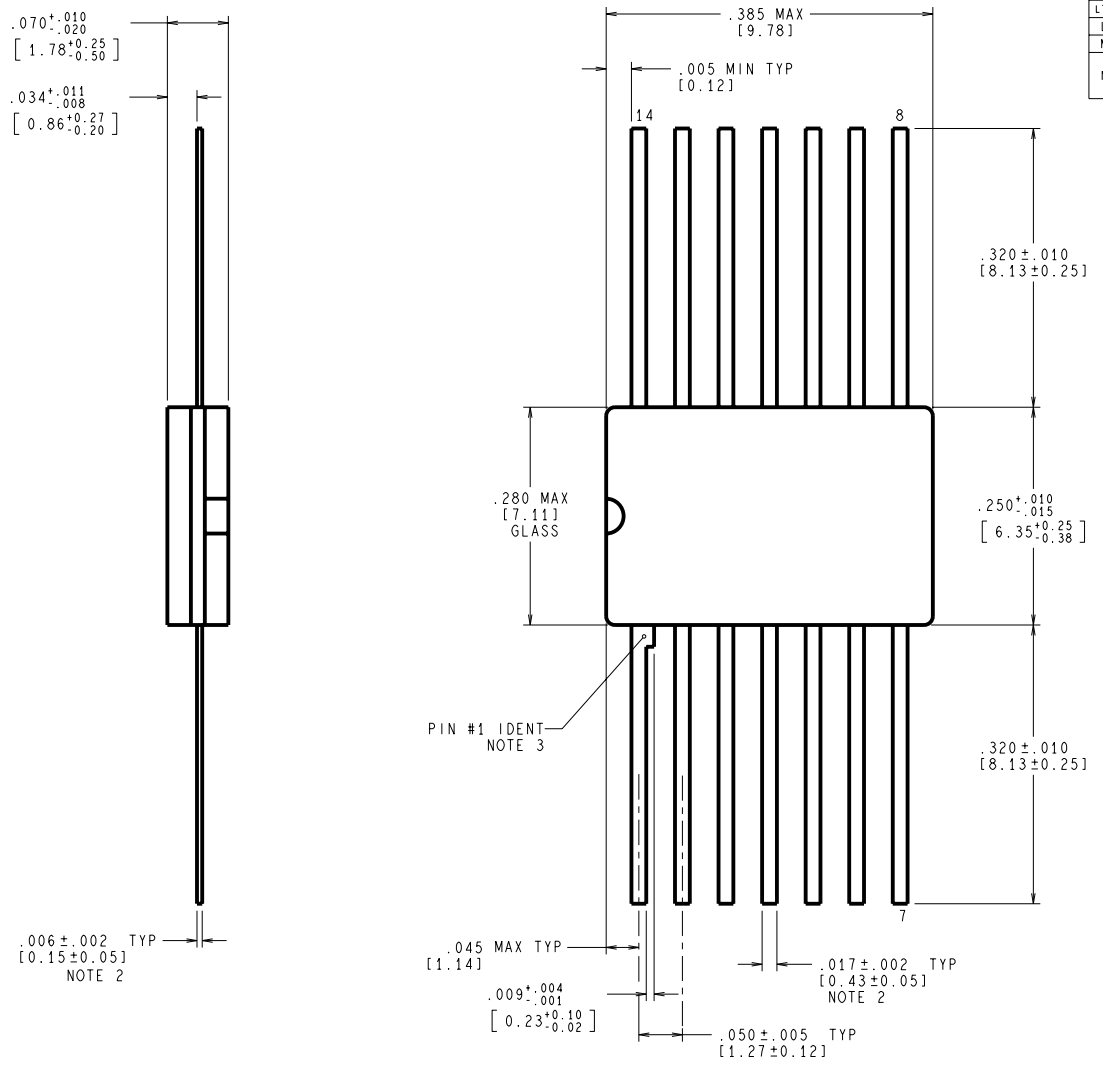
NATIONAL SEMICONDUCTOR CORPORATION
2900 Semiconductor Drive, Santa Clara, CA 95052-8090

CERDIP (J), 14 LEAD,

SCALE	SIZE	DRAWING NUMBER	REV
N/A	B	MKT-J14A	H

DO NOT SCALE DRAWING | SHEET 1 OF 1

REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
L	REVISE AND REDRAW PER NEW STANDARD.	10513	07/26/94	DEG/AEP
M	.017±.002 WAS .017±.020.	10655	10/21/94	DEG/CD
N	L/F THKS .006±.002 WAS .005±.001; UPDATE NOTES 1 & 2; REMOVE NOTE 4; UPDATE MILAERO STAMP; DUAL DIM'S WERE INCHES ONLY.	11005	06/08/95	MS/



NOTES: UNLESS OTHERWISE SPECIFIED.

1. LEAD FINISH: SOLDER DIPPED WITH Sn60 OR Sn63 SOLDER CONFORMING TO MIL-I-38535 TO A MINIMUM THICKNESS OF 200 MICROINCHES/ 5.08 MICROMETERS. SOLDER MAY BE APPLIED OVER LEAD BASIS METAL OR Sn PLATE.
2. MAXIMUM LIMIT MAY BE INCREASED BY .003 INCHES/ 0.08 MILLIMETERS AFTER LEAD FINISH APPLIED.
3. LEAD 1 IDENTIFICATION SHALL BE:
   a) A NOTCH OR OTHER MARK WITHIN THIS AREA
   b) A TAB ON LEAD 1, EITHER SIDE

CONTROLLING DIMENSION IS INCH
VALUES IN [ ] ARE MILLIMETERS

MIL-I-38535
CONFIGURATION CONTROL

APPROVALS	DATE
DRAWN D.E.Grady	07/26/94
DFTG. CHK.	
ENGR. CHK.	

PROJECTION INCH [MM]

National Semiconductor
2900 Semiconductor dr, Santa Clara, CA 95052-8090

CERPACK, 14 LEAD

SCALE	SIZE	DRAWING NUMBER	REV
N/A	C	MKT-W14B	N

DO NOT SCALE DRAWING | SHEET 1 of 1

Revision History

Rev	ECN #	Rel Date	Originator	Changes
1B0	M0004025	07/22/03	Rose Malone	Update MDS: MN54F14-X, Rev. 1A0 to MN54F14-X, Rev. 1B0. Updated NS Part Numbers on Main Table, Added Mkt Dwg.'s to Graphics Section.
2A0	M0004172	07/22/03	Rose Malone	Update MDS: MN54F14-X, Rev. 1B0 to 2A0. Changed DC Electrical Section, Parameter VT limit from 0.4V to 0.3V, typo error.